

Declaration Greenhouse Gas Reporting Program (GHGRP)

Stäubli Electrical Connectors (hereinafter referred to as “STÄUBLI”) is aware of the Greenhouse Gas Reporting Program (GHGRP). STÄUBLI has every intention to contribute to the continuing process for obtaining a cleaner, healthier, and safer environment. We are continuously improving our products and processes.

Under 40 CFR Part 98 Subpart I – Electronics Manufacturing, the electronics manufacturing category consists of facilities engaged in any of the following electronics manufacturing production processes:

- Processes in which etching uses plasma-generated fluorine atoms and other reactive fluorine containing fragments, which chemically react with exposed thin-films (e.g., dielectric, metals) or substrate (e.g., silicon) to selectively remove portions of material;
- Processes in which chambers used for depositing thin films are cleaned periodically using plasma-generated fluorine atoms and other reactive fluorine-containing fragments from fluorinated and other gases;
- Processes in which wafers are cleaned using plasma generated fluorine atoms or other reactive fluorine-containing fragments to remove residual material from wafer surfaces, including the wafer edge;
- Processes in which the chemical vapor deposition process or other production processes use N₂O;
- Processes in which fluorinated GHGs are used as heat transfer fluids (HTF) to cool process equipment, to control temperature during device testing, to clean substrate surfaces and other parts, and for soldering (e.g., vapor phase reflow).

Facilities that use these processes manufacture micro-electromechanical systems (MEMS), liquid crystal displays (LCDs), photovoltaic cells (PV), and semiconductors (incl. light-emitting diodes).

We declare that we do not use any of these processes. We supply connectors to companies that do these processes, but we do not do any of them internally nor in the manufacture of our connectors. Therefore, we are out of scope.

Place/Date of issue Allschwil, 14th February 2024
Signatory (Name/Function)



Christian Gysin
Division Technology Officer



Stefan Liedtke
Managing Director &
Division Supply Chain Officer